## **EAST Search History**

Ref #	Hits	Search Query	DBs	Default Operat or	Plural s	Time Stamp
L1		((trench recess groove open\$3 via hole) and (polysilicon (polycrystalline near5 silicon)) and (CMP polish\$3) and (first near5 temperature) and (second near5 temperature)).clm.	US-PGPU B	OR	ON	2007/01/20 11:06